

#10/notice of
appeal
Brown
4/8/03

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of

Srinivasan Chakravarthi, et al.

TI-33161

Examiner: Yennhu B. Huynh

Art Unit: 2813

Serial No.: 10/020,813

Filed: 12/12/01

For: Fabrication of Abrupt Ultra-Shallow Junctions

NOTICE OF APPEAL FROM THE PRIMARY EXAMINER TO THE BOARD OF APPEALSAssistant Commissioner for Patents
Washington, D. C. 20231**CERTIFICATION OF FACSIMILE TRANSMISSION**I hereby certify that the following papers are being transmitted by facsimile to the
U.S. Patent and Trademark Office on the date shown below:

Karen Vertz
Karen Vertz

4-3-03
Date

Sir:

Applicants hereby appeal to the Board of Appeals from the decision dated January 14, 2003 of the Primary Examiner finally
rejecting claims 1-7.

The item(s) checked below are appropriate:

1. ☐ An extension of time to respond to the final rejection
 ☐ was granted on _____.
 ☐ is requested for _____ month(s).

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2. ☒ A timely response to the final rejection has been filed, as provided in 841 O.G. 1411.
3. ☒ Fee \$310.00:
 ☐ Not required (Fee paid in prior appeal)
 ☒ The Commissioner of Patents is hereby authorized to charge any fees which may be required, or credit any
 overpayment to Deposit Account No. 20-0668 of Texas Instruments Incorporated. This form is submitted in
 triplicate.

Signature [Rule 191(b)]

Post Office Address (to which correspondence is to be sent)

Texas Instruments Incorporated

P.O. Box 655474, MS 3999

Dallas, TX 75265

(972) 917-4167

04/03/2003 DSASFAT 000000006 200668 10020813

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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Applicant Srinivasan Chakravarthi, et al.

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<u>Karen Vertz</u> Karen Vertz	<u>4-3-03</u> Date

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FACSIMILE COVER SHEET

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<input type="checkbox"/> CONTINUATION APP'N (# Pages)	
<input type="checkbox"/> DIVISIONAL APP'N	
NAME OF INVENTOR(S): Srinivasan Chakravarthi, et al.	
TITLE OF INVENTION: Fabrication of Abrupt Ultra-Shallow Junctions	
TI FILE NO.: TI-33161	DEPOSIT ACCT. NO.: 20-0668
FAXED: 4-3-03 DUE: 4-14-03 ATTY/SECY: RAK/kjv	
RECEIPT DATE & SERIAL NO.: Serial No.: 10/020,813 Filing Date: 12/12/01	

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